

2N3583-2N3585, 2N4240

File Number 138

High-Voltage Silicon N-P-N Transistors

For High-Speed Switching and Linear-Amplifier Applications

Features:

- Freedom from second breakdown
- Economy types for ac/dc circuits
- Fast turn-on time at high collector current

RCA-2N3583*, 2N3584*, 2N3585*, and 2N4240*, are silicon n-p-n transistors with high breakdown voltages and fast switching speeds.

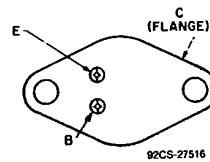
Typical applications for these transistors include high-voltage operational amplifiers, high-voltage switches, switching regulators, converters, inverters, deflection and hi-fi amplifiers.

These transistors are also intended for a wide variety of applications in ac/dc commercial equipment.

All types utilize the JEDEC TO-213AA package.

- Formerly Dev. Nos. TA2510, TA2511, TA2512, and TA2871 respectively.

TERMINAL DESIGNATIONS



JEDEC TO-213AA

MAXIMUM RATINGS, Absolute-Maximum Values:

	2N3583	2N3584	2N3585 2N4240	
• COLLECTOR-TO-BASE VOLTAGE, V_{CBO}	250	375	500	V
• COLLECTOR-TO-EMITTER VOLTAGE, Sustaining, $V_{CEO(SUS)}$	175	250	300	V
• EMITTER-TO-BASE VOLTAGE, V_{EBO}	6	6	6	V
• CONTINUOUS COLLECTOR CURRENT, I_C	1	2	2	A
• PEAK COLLECTOR CURRENT	5	5	5	A
• CONTINUOUS BASE CURRENT, I_B	1	1	1	A
• TRANSISTOR DISSIPATION, P_T	35	35	35	W
At Case Temperature (T_C) = 25°C		Derate Linearly at 0.2		W/°C
At Case Temperatures Above 25°C		Derate Linearly to 200		°C
For Other Conditions				
• TEMPERATURE RANGE:		-65 to +200		°C
Storage and Operating (Junction)				
• PIN TEMPERATURE:				
At distance 1/16 in. (1.58 mm) from seating plane	235	235	235	°C
for 10 s. max.				

* In accordance with JEDEC registration data format JS-6 RDF-2 (2N3583), JS-6 RDF-1 (2N3584, 2N3585, 2N4240).

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ELECTRICAL CHARACTERISTICS at Case Temperature (T_C) = 25°C Unless Otherwise Specified

CHARACTERISTIC	SYMBOL	TEST CONDITIONS						LIMITS								UNITS	
		VOLTAGE V _{dc}				CURRENT mA dc		2N3583		2N3584		2N3585		2N4240			
		V _{CB}	V _{CE}	V _{EB}	V _{BE}	I _C	I _B	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
Collector-Cutoff Current	I _{CEO}	150					0	—	10	—	5	—	5	—	5	mA	
Collector-Cutoff Current	I _{CEX}	225			-1.5			—	1.0	—	—	—	—	—	—	mA	
		340			-1.5			—	—	—	1.0	—	—	—	—	mA	
		450			-1.5			—	—	—	—	1.0	—	—	2.0	mA	
At T _C = 150°C	I _{CEX}	225			-1.5			—	3	—	—	—	—	—	—	mA	
		300			-1.5			—	—	—	3	—	—	—	5.0	mA	
Emitter-Cutoff Current	I _{EBO}		6		-6	0		—	5.0	—	0.5	—	0.5	—	0.5	mA	
DC Forward Current Transfer Ratio	h _{FE}	2				750 ^a		—	—	—	—	—	—	10	100		
		10				1 A ^a		—	—	8	80	8	80	—	—		
		10				100 ^a		40	—	40	—	40	—	40	—		
		10				600 ^a		40	200	—	—	—	—	—	30	150	
		10				750 ^a		10	—	25	100	25	100	—	—	—	
Collector-to-Emitter Sustaining Voltage:																V	
With base open	V _{CEO(sus)}					200	0	175 ^a	—	250 ^a	—	300 ^a	—	300 ^a	—		
With external base-to-emitter resistance (R _{BE}) = 50Ω	I _{CER}	250						—	1.0	—	—	—	—	—	—	mA	
		300						—	—	—	1.0	—	—	—	—	mA	
		400						—	—	—	—	1.0	—	—	—	mA	
Base-to-Emitter Saturation Voltage	V _{BE(sat)}					750 ^a	75	—	—	—	—	—	—	—	—	1.8	V
						1 A ^a	100	—	1.4	—	1.4	—	1.4	—	—	—	V
Collector-to-Emitter Saturation Voltage	V _{CE(sat)}					750 ^a	75	—	—	—	—	—	—	—	—	—	V
						1 A ^a	125	—	5	—	0.75	—	0.75	—	—	—	V
Small-Signal Forward Current Transfer Ratio f = 5 MHz	h _{fe}		10			200		3	—	3	—	3	—	3	—	—	
			30			100		25	350	—	—	—	—	—	—	—	
Magnitudes of Common-Emitter, Small-Signal, Short-Circuit, Forward Current Transfer Ratio f = 5 MHz	h _{fe1}		10			200		2	—	2	—	2	—	3	—	—	
Output Capacitance: V _{CB} = 10 V, f = 1 MHz	C _{obo}	10					0	—	120	—	120	—	120	—	120	pF	
Second-Breakdown Collector Current with base forward-biased** (See Figs 1 & 2)	I _{S/b}		100					350	—	350	—	350	—	350	—	mA	
Saturated Switching Time (V _{CC} = 200 V): Rise Time	t _r	(V _{CC}) 200				1 A 750	100 75	—	—	—	3	—	3	—	—	0.5	
																μs	
Storage Time	t _s	(V _{CC}) 200				1 A 750	100 75	—	—	—	4	—	4	—	—	6	
Fall Time	t _f	(V _{CC}) 200				750 1 A	75 100	—	—	—	3	—	3	—	—	3	
Thermal Resistance: Junction-to-Case	R _{θJC}							—	5	—	5	—	5	—	5	°C/W	
Junction-to-Ambient	R _{θJA}							—	70	—	70	—	70	—	70	°C/W	

^aIn accordance with JEDEC registration data format JS-6 RDF-2 (2N3583), JS-6 RDF-1 (2N3584, 2N3585, 2N4240)

CAUTION: The sustaining voltages V_{CEO(sus)} MUST NOT be measured on a curve tracer.

** Specified value of I_{S/b} for given value of V_{CE} as base voltage is increased from zero in a positive direction.

^a Pulsed, pulse duration = 300 μs; duty factor ≤ 2%.

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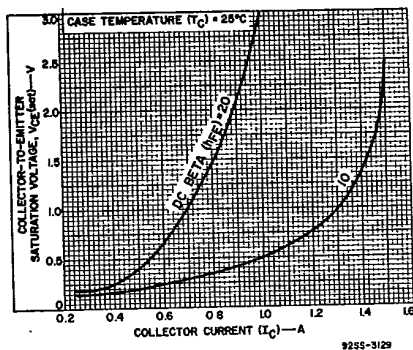


Fig. 3 - Typical collector-to-emitter saturation voltage vs. current for types 2N3584 and 2N3585.

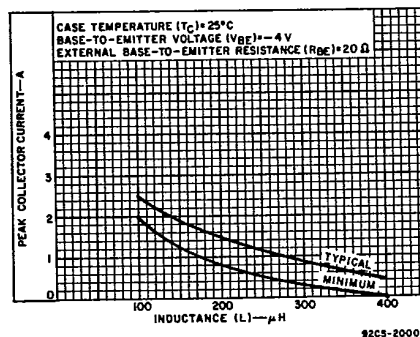


Fig. 4 - Reverse-bias second breakdown characteristics for types 2N3584 and 2N3585.

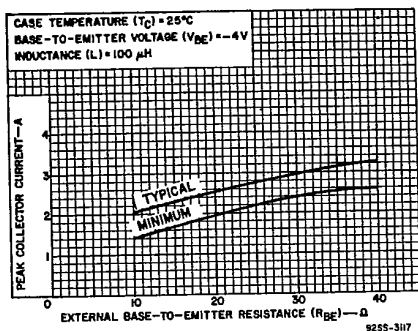


Fig. 5 - Reverse-bias second breakdown characteristics for types 2N3584 and 2N3585.

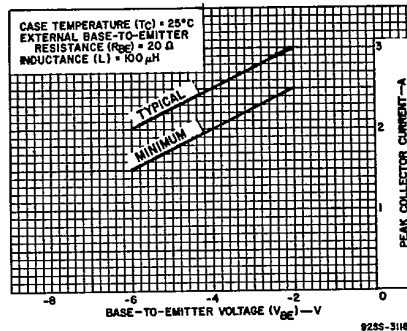


Fig. 6 - Reverse-bias second breakdown characteristics for types 2N3584 and 2N3585.

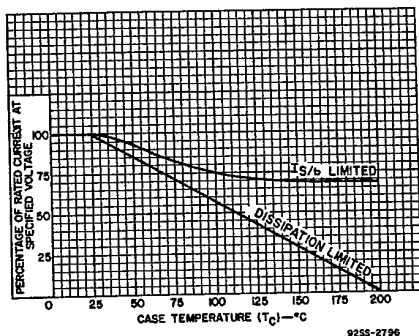


Fig. 7 - Dissipation derating curves for all types.

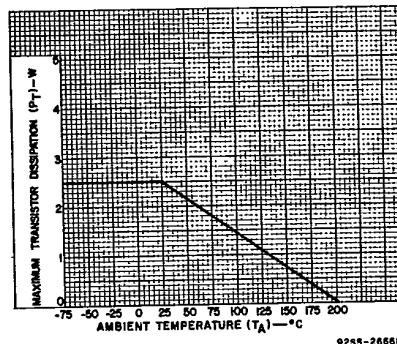


Fig. 8 - Dissipation derating curve for types 2N3583, 2N3584, 2N3585, and 2N4240.

High-Voltage Power Transistors

2N3583-2N3585, 2N4240

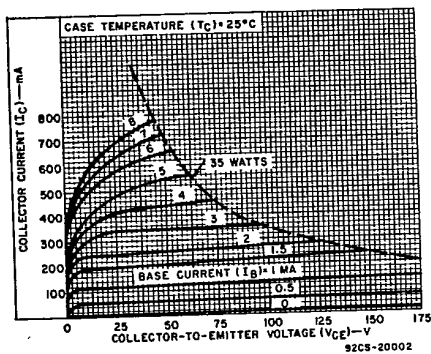


Fig. 9 - Typical output characteristics for type 2N3583.

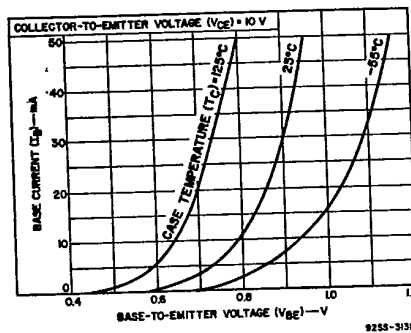


Fig. 10 - Typical input characteristics for all types.

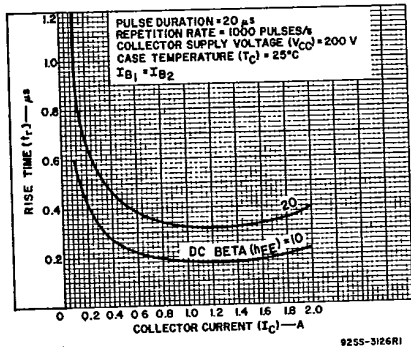


Fig. 11 - Typical rise time vs. collector current for types 2N3584 and 2N3585.

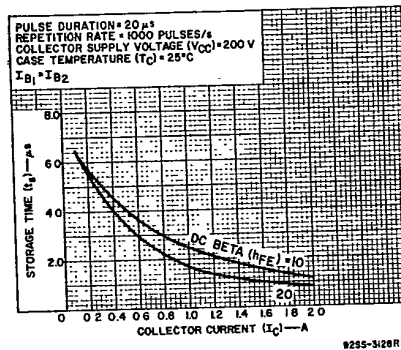


Fig. 12 - Typical storage time vs. collector current for types 2N3584 and 2N3585.

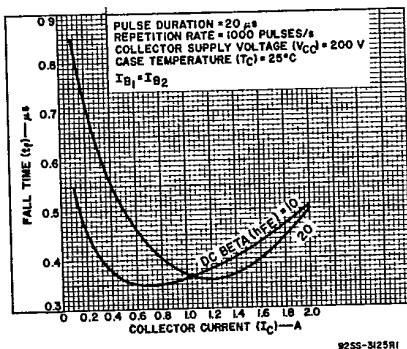


Fig. 13 - Typical fall time vs. collector current for types 2N3584 and 2N3585.

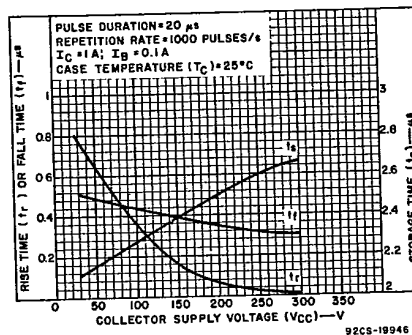


Fig. 14 - Typical rise time, fall time, and storage time vs. collector supply voltage for types 2N3584 and 2N3585.

